

Trench gate field-stop IGBT, M series 650 V, 4 A low loss

Datasheet - production data

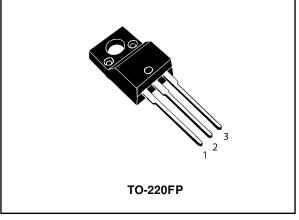
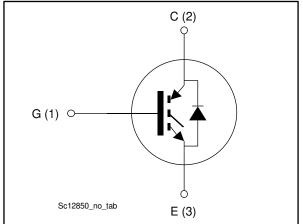


Figure 1: Internal schematic diagram



Features

- 6 µs of short-circuit withstand time
- V_{CE(sat)} = 1.6 V (typ.) @ I_C = 4 A
- Tight parameter distribution
- Safer paralleling
- Low thermal resistance
- Soft and very fast recovery antiparallel diode

Applications

- Motor control
- UPS
- PFC

Description

This device is an IGBT developed using an advanced proprietary trench gate field-stop structure. The device is part of the M series IGBTs, which represent an optimal balance between inverter system performance and efficiency where low-loss and short-circuit functionality are essential. Furthermore, the positive $V_{CE(sat)}$ temperature coefficient and tight parameter distribution result in safer paralleling operation.

Table 1: Device summary

Order code	Marking	Package	Packing
STGF4M65DF2	G4M65DF2	TO-220FP	Tube

DocID028678 Rev 4

This is information on a product in full production.

Contents

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1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
VCES	Collector-emitter voltage (V _{GE} = 0 V)	650	V
lc ⁽¹⁾	Continuous collector current at $T_C = 25 \ ^\circ C$	8	А
IC	Continuous collector current at Tc = 100 °C	4	А
Icp ⁽²⁾	Pulsed collector current	16	А
V_{GE}	Gate-emitter voltage	±20	V
le ⁽¹⁾	Continuous forward current at $T_C = 25$ °C	8	А
IF	Continuous forward current at $T_c = 100$ °C	4	А
I _{FP} ⁽²⁾	Pulsed forward current	16	А
Viso	Insulation withstand voltage (RMS) from all three leads to external heat sink (t=1s, TC= 25 $^{\circ}$ C)	2.5	kV
Ртот	Total dissipation at $T_C = 25 \text{ °C}$	23	W
Tstg	Storage temperature range	- 55 to 150	°C
TJ	Operating junction temperature range	- 55 to 175	°C

Notes:

⁽¹⁾Limited by maximum junction temperature.

 $^{(2)}\mbox{Pulse}$ width limited by maximum junction temperature.

Table 3: Thermal data

Symbol	Parameter	Value	Unit
RthJC	Thermal resistance junction-case IGBT	6.5	°C/W
RthJC	Thermal resistance junction-case diode	7	°C/W
R _{thJA}	Thermal resistance junction-ambient		°C/W



2 Electrical characteristics

 $T_C = 25$ °C unless otherwise specified

l able 4: Static characteristics						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)CES}$	Collector-emitter breakdown voltage	$V_{GE}=0~V,~I_C=250~\mu A$	650			V
		V_{GE} = 15 V, I_C = 4 A		1.6	2.1	
VCE(sat)	Collector-emitter saturation voltage	$V_{GE} = 15 V, I_C = 4 A, T_J = 125 \ ^{\circ}C$		1.9		v
		$V_{GE} = 15 V, I_C = 4 A, T_J = 175 \ ^{\circ}C$		2.1		
		IF = 4 A		1.9		
VF	Forward on-voltage	I _F = 4 A, T _J = 125 °C		1.7		V
		I _F = 4 A, T _J = 175 °C		1.6		
$V_{\text{GE(th)}}$	Gate threshold voltage	V_{CE} = V_{GE} , I_C = 250 μ A	5	6	7	V
ICES	Collector cut-off current	$V_{GE} = 0 V, V_{CE} = 650 V$			25	μA
I _{GES}	Gate-emitter leakage current	$V_{CE}=0~V,~V_{GE}=\pm~20~V$			±250	μΑ

Table 4: Static characteristics

Table 5: Dynamic characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Cies	Input capacitance		-	369	-	
Coes	Output capacitance	V _{CE} = 25 V, f = 1 MHz, V _{GE} = 0 V	-	24.8	-	pF
Cres	Reverse transfer capacitance		-	8	-	
Qg	Total gate charge	Vcc = 520 V, Ic = 4 A,	-	15.2	-	
Q _{ge}	Gate-emitter charge	V _{GE} = 15 V (see <i>Figure 30: " Gate</i>	-	3	-	nC
Q _{gc}	Gate-collector charge	charge test circuit")	-	7	-	

Electrical characteristics

	Table 6: IGBT switching characteristics (inductive load)						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
td(on)	Turn-on delay time			12	-	ns	
tr	Current rise time			6.9	-	ns	
(di/dt) _{on}	Turn-on current slope	$V_{CE} = 400 \text{ V}, \text{ Ic} = 4 \text{ A},$		480	-	A/µs	
td(off)	Turn-off-delay time	$V_{GE} = 15 \text{ V}, \text{ R}_{G} = 47 \Omega$		86	-	ns	
t _f	Current fall time	(see Figure 29: "Test circuit for inductive load		120	-	ns	
Eon ⁽¹⁾	Turn-on switching energy	switching")		0.040	-	mJ	
E _{off} ⁽²⁾	Turn-off switching energy			0.136	-	mJ	
Ets	Total switching energy			0.176	-	mJ	
td(on)	Turn-on delay time			11.6	-	ns	
tr	Current rise time			8	-	ns	
(di/dt) _{on}	Turn-on current slope	$V_{CE} = 400 V, I_C = 4 A,$		410	-	A/µs	
td(off)	Turn-off-delay time	$V_{GE} = 15 V, R_G = 47 \Omega,$		85	-	ns	
tſ	Current fall time	T _J = 175 °C (see <i>Figure 29: " Test circuit</i>		211	-	ns	
Eon ⁽¹⁾	Turn-on switching energy	for inductive load switching")		0.067	-	mJ	
E _{off} ⁽²⁾	Turn-off switching energy			0.210	-	mJ	
Ets	Total switching energy			0.277	-	mJ	
+	Chart airquit withstand time	$\label{eq:VCC} \begin{array}{l} V_{CC} \leq 400 \ V, \ V_{GE} = 15 \ V, \\ T_{Jstart} = 150 \ ^{\circ}C \end{array}$	6		-	μs	
t _{sc}	Short-circuit withstand time	$\label{eq:VCC} \begin{array}{l} V_{CC} \leq 400 \mbox{ V}, V_{GE} = 13 \mbox{ V}, \\ T_{Jstart} = 150 ^{\circ} \mbox{C} \end{array}$	10		-	μs	

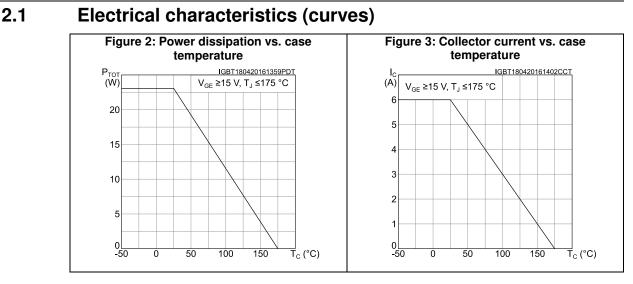
Notes:

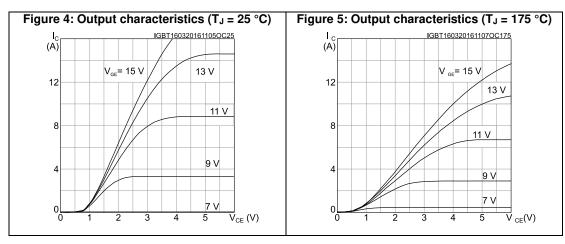
⁽¹⁾Including the reverse recovery of the diode. ⁽²⁾Including the tail of the collector current.

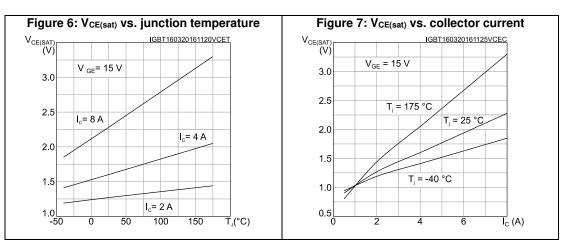
Symbol	Parameter Test conditions		Min.	Тур.	Max.	Unit
trr	Reverse recovery time		-	133	-	ns
Qrr	Reverse recovery charge	I _F = 4 A, V _B = 400 V,	-	140	-	nC
Irrm	Reverse recovery current	V _{GE} = 15 V, di/dt = 800 A/µs	-	5	-	А
dIrr/dt	Peak rate of fall of reverse recovery current during $t_{\mbox{\scriptsize b}}$	(see Figure 29: " Test circuit for inductive load switching")	-	520	-	A/µs
Err	Reverse recovery energy		-	15	-	μJ
t _{rr}	Reverse recovery time		-	236	-	ns
Qrr	Reverse recovery charge	$I_F = 4 A, V_R = 400 V,$	-	370	-	nC
Irrm	Reverse recovery current	V _{GE} = 15 V, T _J = 175 °C, di/dt = 800 A/μs	-	6.6	-	А
dIrr/dt	Peak rate of fall of reverse recovery current during tb	(see Figure 29: " Test circuit for inductive load switching")	-	378	-	A/µs
Err	Reverse recovery energy		-	32	-	μJ

Table 7. Diada awitabing	abaraatariatiaa	(inductive lead)
Table 7: Diode switching	characteristics	(inductive load)











Δ

0

6

T_i = 175 °C

11

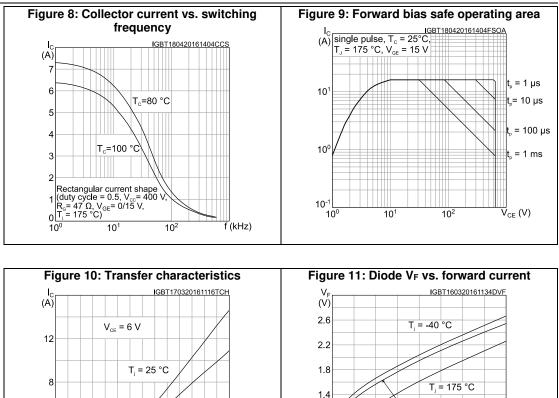
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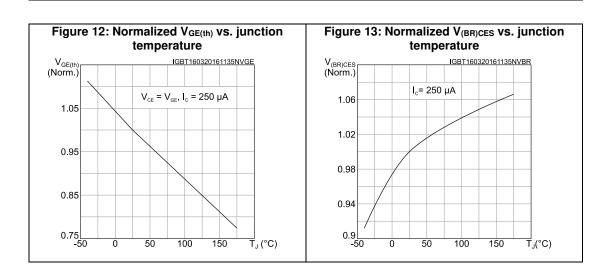
 $\overline{V}_{GE}(V)$

10

8 9

Electrical characteristics





1.0

0.6 0.2 T, = 25 °C

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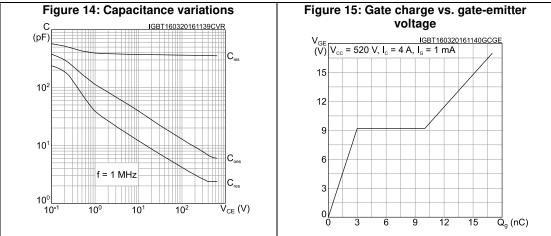
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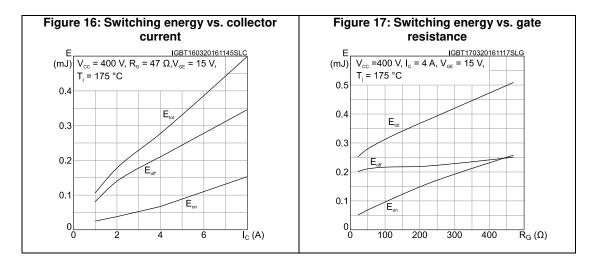
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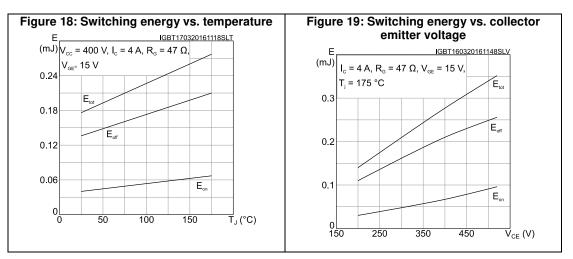
 $\vec{\mathsf{I}}_{\mathsf{F}}(\mathsf{A})$

Electrical characteristics

STGF4M65DF2





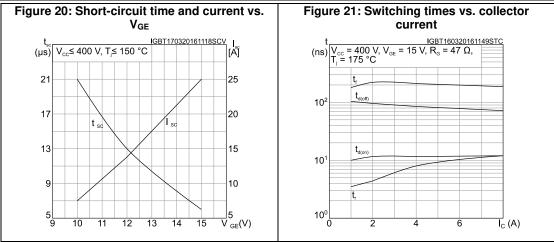


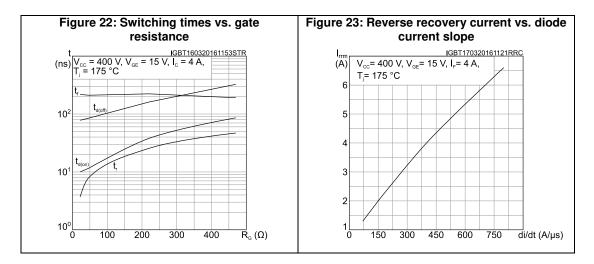
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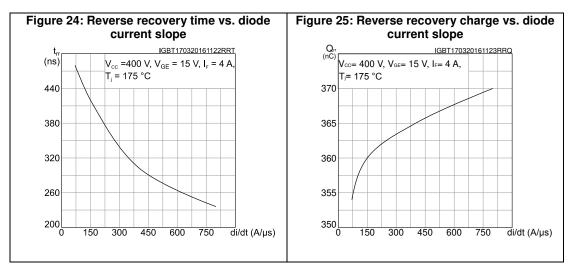


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Electrical characteristics



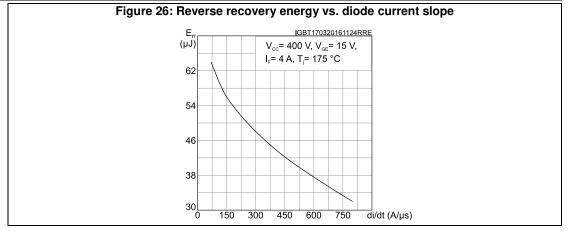


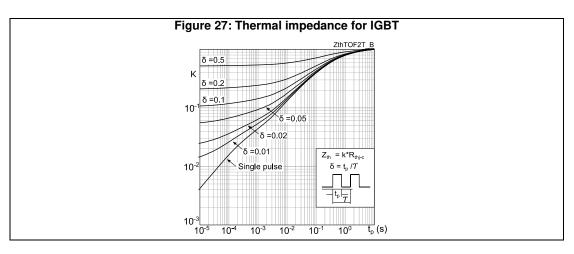


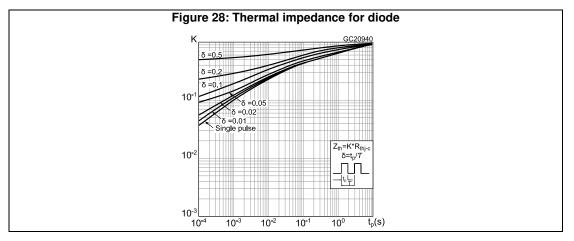
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Electrical characteristics

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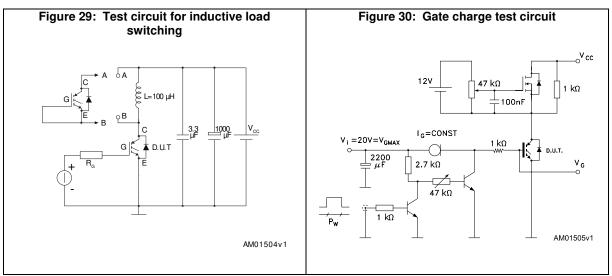


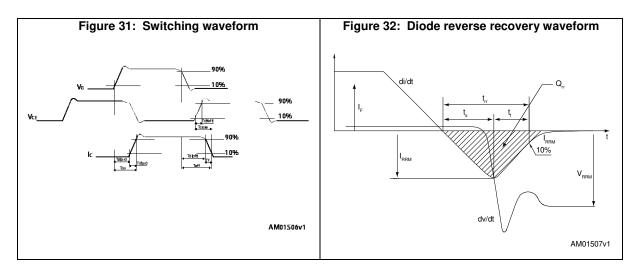






3 Test circuits







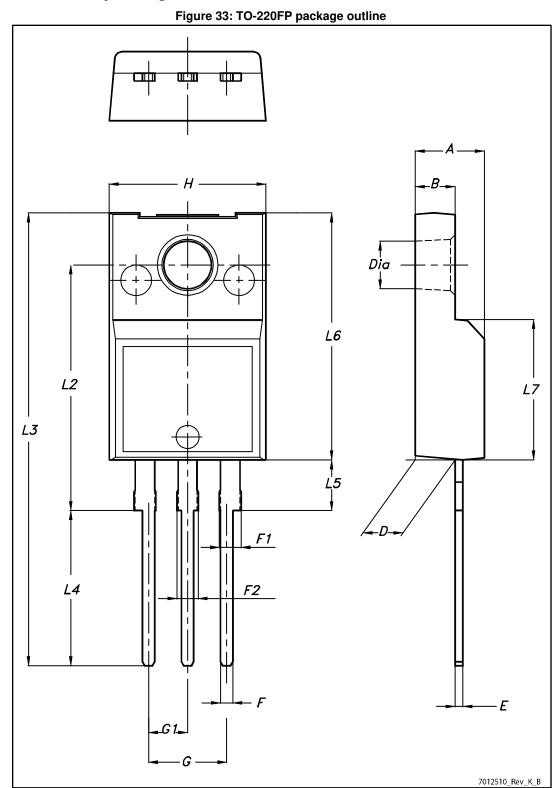
4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.



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4.1 TO-220FP package information



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Package information

Table 8: TO-220FP package mechanical data

STGF4M65DF2

Table 8: TO-220FP package mechanical data				
Dim.		mm		
Dim.	Min.	Тур.	Max.	
A	4.4		4.6	
В	2.5		2.7	
D	2.5		2.75	
E	0.45		0.7	
F	0.75		1	
F1	1.15		1.70	
F2	1.15		1.70	
G	4.95		5.2	
G1	2.4		2.7	
Н	10		10.4	
L2		16		
L3	28.6		30.6	
L4	9.8		10.6	
L5	2.9		3.6	
L6	15.9		16.4	
L7	9		9.3	
Dia	3		3.2	



5 Revision history

Table 9: Document revision history

Date	Revision	Changes
25-Nov-2015	1	First release.
18-Apr-2016	2	Modified: features in cover page. Modified: Table 2: "Absolute maximum ratings", Table 3: "Thermal data", Table 4: "Static characteristics", Table 5: "Dynamic characteristics", Table 6: "IGBT switching characteristics (inductive load)" and Table 7: "Diode switching characteristics (inductive load)" Added: Section 2.1: "Electrical characteristics (curves)". Minor text changes
13-Jul-2016	3	Document status promoted from preliminary to production data.
21-Nov-2016	4	Updated Figure 1: "Internal schematic diagram" Updated Table 2: "Absolute maximum ratings" Updated Figure 25: "Reverse recovery charge vs. diode current slope" Minor text changes



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